



Features

Side Configuration

Floating High-Side Operates to 600V

**Outputs Tolerant To Negative Transients** 

2.5A Sink/2.5A Source Typical Output Currents

Wide Gate Driver Supply Voltage Range: 10V to 20V

Wide Logic Input Supply Voltage Range: 3.3V to 20V Wide Logic Supply Offset Voltage Range: -5V to 5V

15ns (typ) Rise/13ns (typ) Fall Times with 1000pF load

Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2) Halogen and Antimony free. "Green" Device (Note 3)

For automotive applications requiring specific change

control (i.e. parts gualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities),

please contact us or your local Diodes representative.

https://www.diodes.com/guality/product-definitions/

105ns (typ) Turn-On/94ns (typ) Turn-Off Delay Times

Cycle-by-Cycle Edge-Triggered Shutdown Circuitry

Extended Temperature Range: -40°C to +125°C

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#### **HIGH-SIDE AND LOW-SIDE GATE DRIVERS IN SO-16**

Drives two N-Channel MOSFETs or IGBTs in High-Side/Low-

#### Description

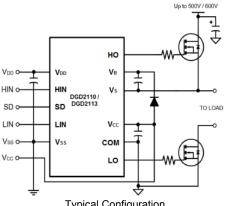
The DGD2110 and DGD2113 are high-voltage/high-speed MOSFET and IGBT drivers with independent high-side and low-side outputs. The high-side driver features floating supply for operation at up to 500V/600V. The 10ns (max)/20ns (max) propagation delay matching between the high- and the low side drivers allows high-frequency operation.

The DGD2110 and DGD2113 logic inputs are compatible with standard CMOS levels (as low as 3.3V) while driver outputs feature high-pulse current buffers designed for minimum driver cross conduction.

The DGD2110 and DGD2113 are offered in a SO-16 package. They operate over an extended -40°C to +125°C temperature range.

#### Applications

- **DC-DC Converters**
- **DC-AC Inverters**
- AC-DC Power Supplies
- Motor Controls
- **Class D Power Amplifiers**



#### Ordering Information (Note 4)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
DGD2110S16-13	DGD2110	13	16	1500
DGD2113S16-13	DGD2113	13	16	1500

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

#### Marking Information

Notes:



Characteria Control Contro DGD211x = Product Type Marking Code (See Table Above) YY = Year (ex: 19 = 2019) WW = Week (01 - 53)

#### October 2019 © Diodes Incorporated

# SO-16 **Typical Configuration** Top View

Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Classification Rating 94V-0 Moisture Sensitivity: Level 3 per J-STD-020 Terminals: Finish-Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 @3 Weight: 0.130 grams (Approximate)

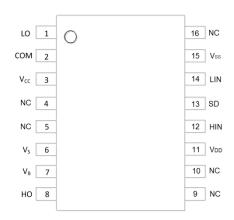
Mechanical Data

Case: SO-16 (Type TH)





**Pin Diagrams** 

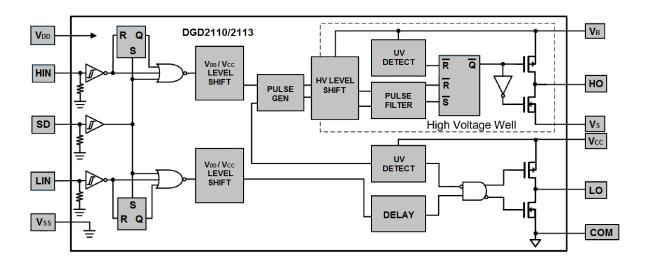


#### Top view: SO-16

### **Pin Descriptions**

Pin Number	Pin Name	Function
1	LO	Low-side gate driver output pin
2	COM	Low-side gate driver power supply return pin
3	Vcc	Low-side gate driver power supply pin
4,5,9,10,16	NC	No connect pin (No Internal Connection)
6	Vs	High-side gate driver floating power supply return pin
7	VB	High-side gate driver floating power supply pin
8	HO	High-side gate drive output pin
11	V <sub>DD</sub>	Logic power supply pin
12	HIN	Logic input pin for high-side gate driver output. HIN and HO are in phase
13	SD	Logic input shutdown pin
14	LIN	Logic input pin for low-side gate driver output. LIN and LO are in phase
15	V <sub>SS</sub>	Logic ground pin

# **Functional Block Diagram**





### Absolute Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
High-Side Floating Supply Voltage (DGD2110)	VB	-0.3 to +524	V
High-Side Floating Supply Voltage (DGD2113)	VB	-0.3 to +624	V
High-Side Floating Supply Offset Voltage	Vs	V <sub>B</sub> -24 to V <sub>B</sub> +0.3	V
High-Side Floating Output Voltage	V <sub>HO</sub>	$V_{\rm S}$ -0.3 to $V_{\rm S}$ +0.3	V
Offset Supply Voltage Transient	dV <sub>S</sub> / dt	50	V/ns
Low-Side Fixed Supply Voltage	V <sub>CC</sub>	-0.3 to +24	V
Low-Side Output Voltage	V <sub>LO</sub>	-0.3 to V <sub>CC</sub> +0.3	V
Logic Supply Voltage	V <sub>DD</sub>	-0.3 to V <sub>SS</sub> +24	V
Logic Supply Offset Voltage	V <sub>SS</sub>	V <sub>CC</sub> -24 to V <sub>CC</sub> +0.3	V
Logic Input Voltage (HIN, LIN, and SD)	V <sub>IN</sub>	V <sub>SS</sub> -0.3 to V <sub>DD</sub> +0.3	V

### Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation Linear Derating Factor (Note 5)	PD	1.25	W
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>0JA</sub>	90	°C/W
Thermal Resistance, Junction to Case (Note 5)	Rejc	45	°C/W
Operating Temperature	TJ	+150	
Lead Temperature (Soldering, 10 seconds)	TL	+300	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	

Note: 5. When mounted on a standard JEDEC 2-layer FR-4 board.

### **Recommended Operating Conditions**

Parameter	Symbol	Min	Max	Unit V	
High-Side Floating Supply Absolute Voltage	VB	V <sub>S</sub> + 10	V <sub>S</sub> + 20		
High-Side Floating Supply Offset Voltage	DGD2110	Vs	(Note 6)	500	V
High-Side Floating Supply Offset Voltage	DGD2113	Vs	(Note 6)	600	V
High-Side Floating Output Voltage	<u>.</u>	V <sub>HO</sub>	Vs	VB	V
Low-Side Fixed Supply Voltage	Vcc	10	20	V	
Low-Side Output Voltage	V <sub>LO</sub>	0	V <sub>CC</sub>	V	
Logic Supply Voltage		V <sub>DD</sub>	V <sub>SS</sub> + 3	V <sub>SS</sub> + 20	V
Logic Supply Offset Voltage		Vss	-5 (Note 7)	5	V
Logic Input Voltage (HIN, LIN, and SD)	VIN	V <sub>SS</sub>	V <sub>DD</sub>	V	
Ambient Temperature		T <sub>A</sub>	-40	+125	°C

Notes: 6. Logic operation for  $V_S = -4V$  to +500V.

7. When  $V_{DD}$  <5V, the minumum V<sub>SS</sub> offset is limited to -V<sub>DD</sub>.



# DC Electrical Characteristics (V<sub>BIAS</sub> (V<sub>CC</sub>, V<sub>BS</sub>, V<sub>DD</sub>) = 15V, V<sub>SS</sub> = COM, @T<sub>A</sub> = +25°C unless otherwise specified.) (Note 8)

Parameter	Symbol	Min	Тур	Max	Unit	Conditions
Logic "1" Input Voltage (Note 9)	VIH	9.5		_	V	—
Logic "0" Input Voltage (Note 9)	VIL	—	_	6.0	V	—
High Level Output Voltage, V <sub>BIAS</sub> - V <sub>O</sub>	Voh	—	-	1.4	V	I <sub>O</sub> = 0mA
Low Level Output Voltage, Vo	V <sub>OL</sub>	—	-	0.15	V	I <sub>O</sub> = 20mA
Offset Supply Leakage Current	I <sub>LK</sub>	—	-	50	μA	$V_{B} = V_{S} = 500V/600V$
Quiescent V <sub>BS</sub> Supply Current	I <sub>BSQ</sub>	—	55	230	μA	$V_{IN} = 0V \text{ or } V_{DD}$
Quiescent V <sub>CC</sub> Supply Current	Iccq	—	56	340	μA	$V_{IN} = 0V \text{ or } V_{DD}$
Quiescent V <sub>DD</sub> Supply Current	IDDQ	—	0.6	30	μA	$V_{IN} = 0V \text{ or } V_{DD}$
Logic "1" Input Bias Current	I <sub>IN+</sub>	—	20	40	μA	$V_{IN} = V_{DD}$
Logic "0" Input Bias Current	I <sub>IN-</sub>	—	-	5.0	μA	$V_{IN} = 0V$
V <sub>BS</sub> Supply Undervoltage Positive Going Threshold	V <sub>BSUV+</sub>	7.5	8.6	9.7	V	—
V <sub>BS</sub> Supply Undervoltage Negative Going Threshold	V <sub>BSUV-</sub>	7.0	8.2	9.4	V	—
V <sub>CC</sub> Supply Undervoltage Positive Going Threshold	V <sub>CCUV+</sub>	7.4	8.5	9.6	V	—
V <sub>CC</sub> Supply Undervoltage Negative Going Threshold	V <sub>CCUV-</sub>	7.0	8.2	9.4	V	—
Output High Short Circuit Pulsed Current	I <sub>O+</sub>	2.0	2.5	_	A	V <sub>O</sub> = 0V, V <sub>IN</sub> = V <sub>DD</sub> , PW ≤ 10µs
Output Low Short Circuit Pulsed Current	I <sub>O-</sub>	2.0	2.5	—	А	V <sub>O</sub> = 15V, V <sub>IN</sub> = 0V, PW ≤ 10µs

Note: 8. The V<sub>IN</sub> and I<sub>IN</sub> parameters are referenced to V<sub>SS</sub> and are applicable to all three logic input pins: HIN, LIN, and SD. The V<sub>O</sub> and I<sub>O</sub> parameters are referenced to COM and are applicable to the respective output pins: HO and LO.

9. For optimal operation, it is recommended that the input pulses (HIN and LIN) should have a minimum amplitude of 9.5V (VDD = 15V) with a minimum pulse width of 200ns.

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Parameter		Symbol	Min	Тур	Max	Unit	Conditions
Turn-On Propagation Delay		t <sub>ON</sub>	—	105	150	ns	V <sub>S</sub> = 0V
Turn-Off Propagation Delay		toff	—	94	125	ns	V <sub>S</sub> = 500V/600V
Shut Down Propagation Delay		t <sub>SD</sub>	—	70	140	ns	V <sub>S</sub> = 500V/600V
Turn-On Rise Time		tr	—	15	35	ns	—
Turn-Off Fall Time		t <sub>f</sub>	—	13	25	ns	—
Delay Matching	DGD2110	t <sub>DM</sub>	—	—	10	—	-
Delay Matching	DGD2113	t <sub>DM</sub>	_	—	20	_	-

AC Electrical Characteristics (V<sub>BIAS</sub> (V<sub>CC</sub>, V<sub>BS</sub>, V<sub>DD</sub>) = 15V, C<sub>L</sub> = 1000pF, V<sub>SS</sub> = COM, @T<sub>A</sub> = +25°C, unless otherwise specified.)



### **Timing Waveforms**

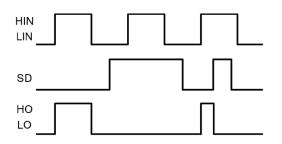


Figure 1. Input / Output Timing Diagram

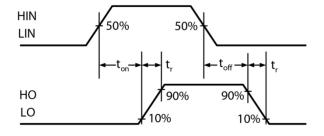


Figure 2. Switching Time Waveform Definitions

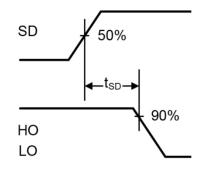


Figure 3. Shutdown Waveform Definitions

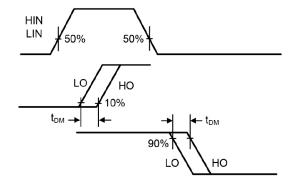


Figure 4. Delay Matching Waveform Definitions



#### Typical Performance Characteristics (Vcc=15V, @TA = +25°C, unless otherwise specified.)

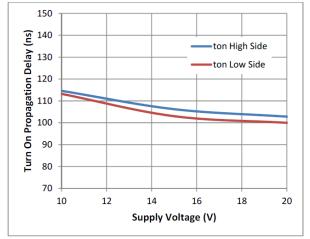


Figure 5. Turn-on Propogation Delay vs. Supply Voltage

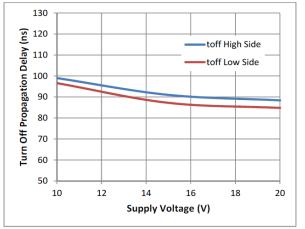


Figure 7. Turn-off Propogation Delay vs. Supply Voltage

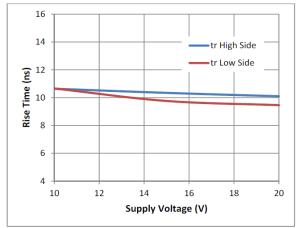


Figure 9. Rise Time vs. Supply Voltage

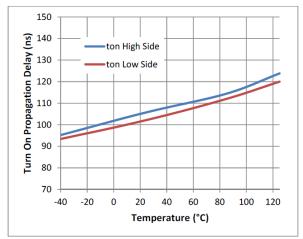


Figure 6. Turn-on Propogation Delay vs. Temperature

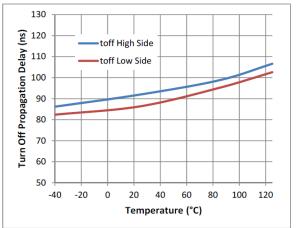
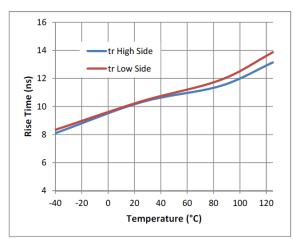


Figure 8. Turn-off Propogation Delay vs. Temperature







### Typical Performance Characteristics (continued)

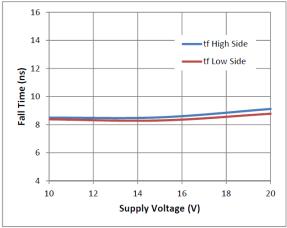


Figure 11. Fall Time vs. Supply Voltage

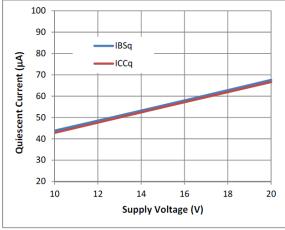


Figure 13. Quiescent Current vs. Supply Voltage

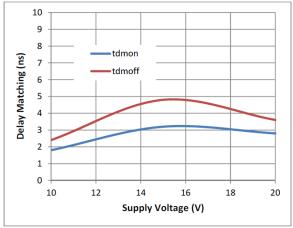


Figure 15. Delay Matching vs. Supply Voltage

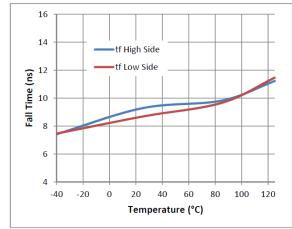


Figure 12. Fall Time vs. Temperature

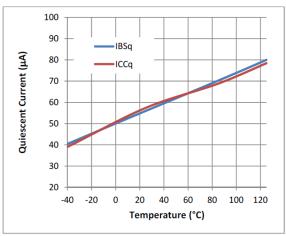


Figure 14. Quiescent Current vs. Temperature

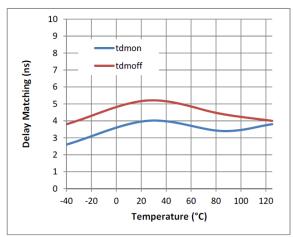


Figure 16. Delay Matching vs. Temperature



### Typical Performance Characteristics (cont.)

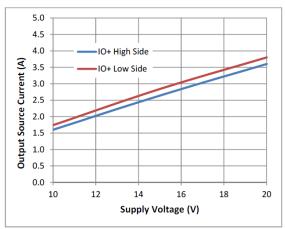
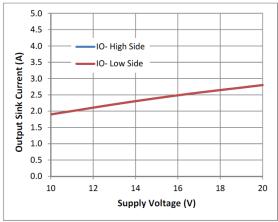


Figure 17. Output Source Current vs. Supply Voltage



**Figure 19.** Output Sink Current vs. Supply Voltage Note: graphs overlap one another

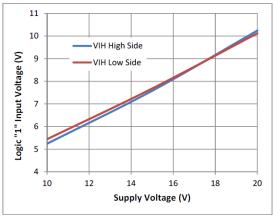


Figure 21. Logic 1 Input Voltage vs. Supply Voltage

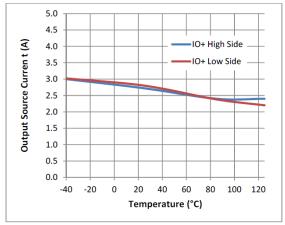


Figure 18. Output Source Current vs. Temperature

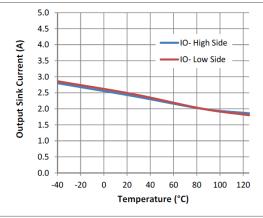


Figure 20. Output Sink Current vs. Temperature

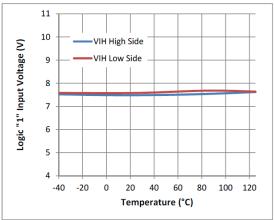


Figure 22. Logic 1 Input Voltage vs. Temperature



### Typical Performance Characteristics (cont.)

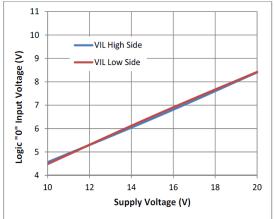


Figure 23. Logic 0 Input Voltage vs. Supply Voltage

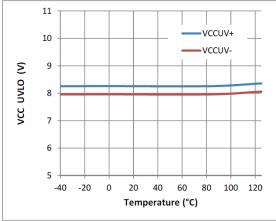


Figure 25. V<sub>cc</sub> UVLO vs. Temperature

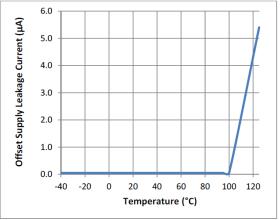


Figure 27. Offset Supply Leakage Current vs. Temperature

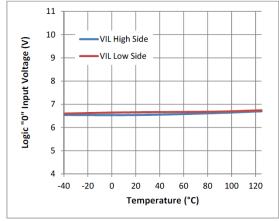


Figure 24. Logic 0 Input Voltage vs. Temperature

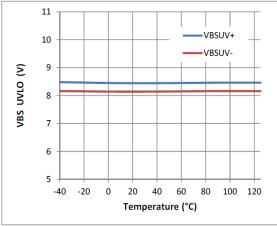


Figure 26. V<sub>BS</sub> UVLO vs. Temperature

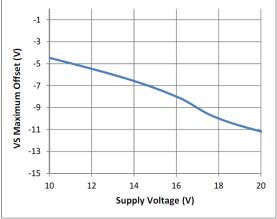


Figure 28. V<sub>s</sub> Maximum Offset vs. Supply Voltage



#### Typical Performance Characteristics (cont.)

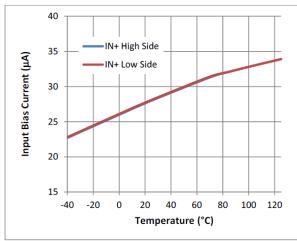


Figure 29. Input Bias Current vs. Temperature

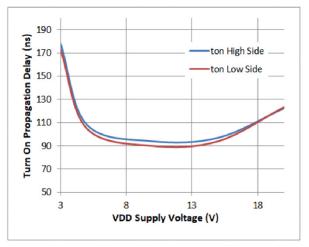


Figure 31. Turn-On Propagation Delay vs. Logic Supply Voltage

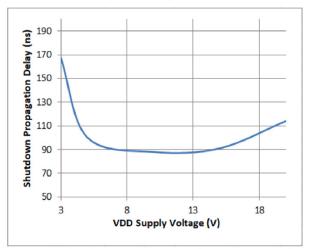


Figure 33. Shutdown Propagation Delay vs. Logic Supply Voltage

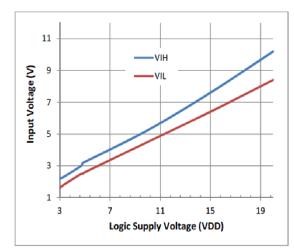


Figure 30. Input Voltage vs. Logic Supply Voltage

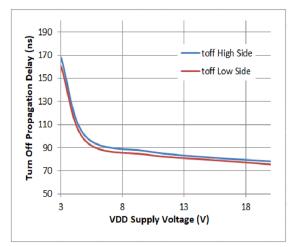
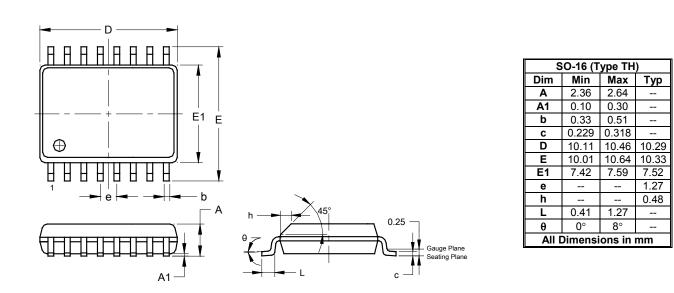


Figure 32. Turn-Off Propagation Delay vs. Logic Supply Voltage



#### **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

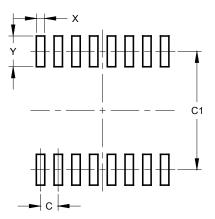


SO-16 (Type TH)

### **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.





Dimensions	Value (in mm)
C	1.27
C1	8.46
Х	0.60
Y	2.20

Note: For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device Terminals and PCB tracking.



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